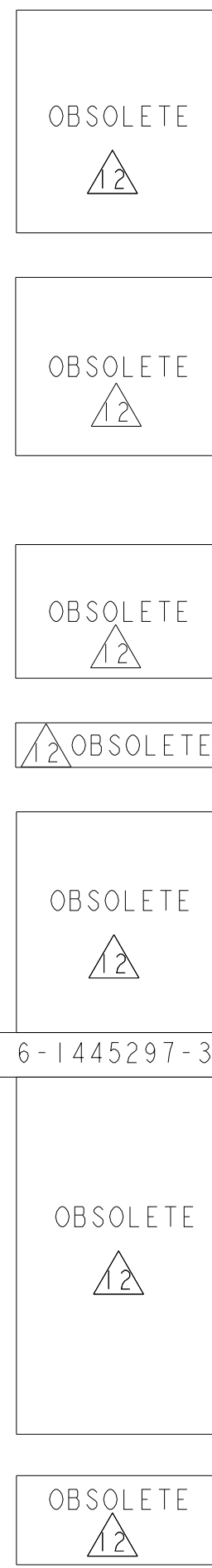
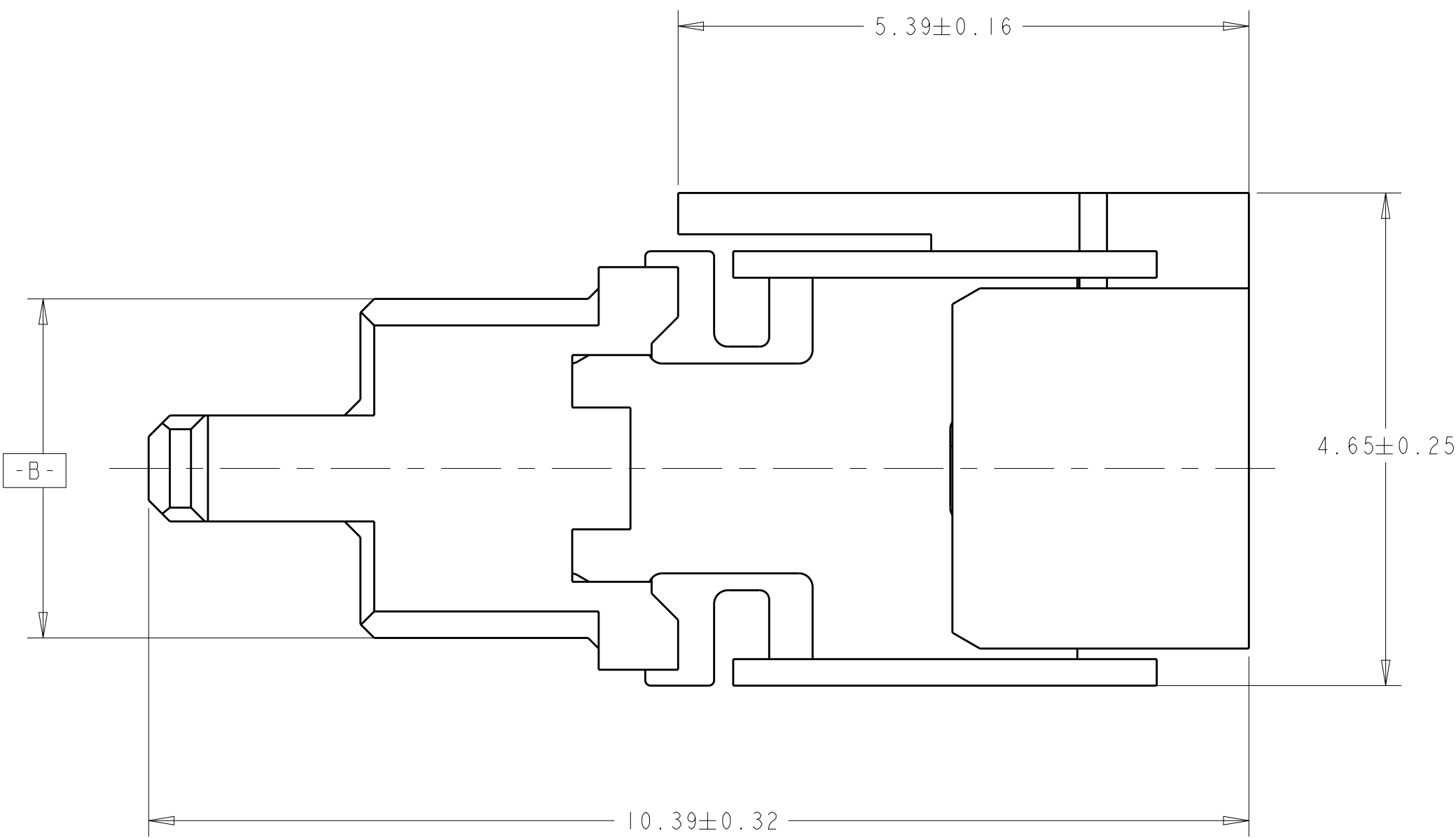


- △ HOUSING & ORGANIZER MATERIAL; UL94 V-0 RATED LCP, COLOR: NATURAL
CONTACT MATERIAL; PHOS BRONZE
BOARDLOCK MATERIAL; BRASS
- △ CONTACT PLATING; 0.76 μm MIN GOLD IN MATING AREA
2.54 μm - 5.08 μm MATTE TIN LEAD IN SOLDER AREA.
BOTH OVER 1.27 μm MIN NICKEL ON ENTIRE STOCK.
- △ BOARDLOCK PLATING; 3.8 μm MIN BRIGHT TIN/LEAD ON ENTIRE STOCK
OVER 1.27 μm MIN NICKEL ON ENTIRE STOCK.
- △ DATUM ESTABLISHED BY CUSTOMER.
- △ BASIC DIMENSIONS ESTABLISHED BY CUSTOMER.
6. THIS PRODUCT HAS NOT COMPLETED VALIDATION TESTING.
- △ NO TRACES ON EXTERNAL BOARD LAYER IN THIS AREA, KEEPOUT.
- △ NO SOLDER PASTE PERMITTED ON THESE PADS.
- △ CONTACT PLATING; 0.76 μm MIN GOLD IN MATING AREA
2.54 μm - 5.08 μm TIN IN SOLDER AREA.
BOTH OVER 1.27 μm MIN NICKEL ON ENTIRE STOCK.
- △ BOARDLOCK PLATING; 3.8 μm MIN TIN ON ENTIRE STOCK
OVER 1.27 μm MIN NICKEL ON ENTIRE STOCK.
- △ ROHS 2002/95/EC COMPLIANT.
- △ OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI



THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN R. J. KOLLER 14MAY2001 CHK - 07AUG2001 BY BREKOSKY		 TE Connectivity	
DIMENSIONS: mm 		TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PL/C ±.1 1 PL/C ±0.2 2 PL/C ±0.08 3 PL/C ±.1 4 PL/C ±.1 ANGLES ±1° FINISH		NAME AMPMODU MICRO INTERCONNECT RECEPTACLE ASSEMBLY, RIGHT ANGLE	
MATERIAL 		APPLICATION SPEC SEE TABLE		SIZE A1	
		WEIGHT -		CASE CODE -	
		Customer Drawing		DRAWING NO C=1445297	
				RESTRICTED TO -	
				SCALE 20:1 SHEET 1 OF 1 REV B	



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